



Shenzhen Tuofeng Semiconductor Technology Co., Ltd

P -CHANNEL ENHANCEMENT MODE POWER MOSFET**TF150P03L****• General Description**

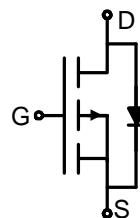
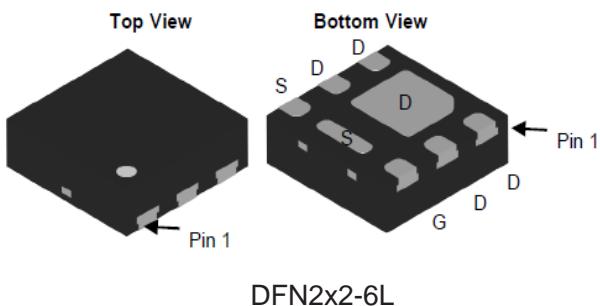
The TF150P03L combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$.

• Features

- Advance high cell density Trench technology
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

• Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

• Product Summary $V_{DS} = -30V \quad I_D = -12A$ $R_{DS(on)(-10V typ)} = 13m\Omega$ $R_{DS(on)(-4.5V typ)} = 18m\Omega$ **• Ordering Information:**

Part NO.	TF150P03L
Marking1	4419:TF150P03L
Marking2	Y:year code; XX:Week; A:device code;
Basic ordering unit (pcs)	3000

• Absolute Maximum Ratings ($T_C = 25^\circ C$)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	$I_D @ T_C = 25^\circ C$	-12	A
	$I_D @ T_C = 75^\circ C$	-9.0	A
	$I_D @ T_C = 100^\circ C$	-5.5	A
Pulsed Drain Current ^①	I_{DM}	-36	A
Total Power Dissipation ^②	$P_D @ T_C = 25^\circ C$	16	W
Total Power Dissipation	$P_D @ T_A = 25^\circ C$	0.9	W
Operating Junction Temperature	T_J	-55 to 150	°C
Storage Temperature	T_{STG}	-55 to 150	°C



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P -CHANNEL ENHANCEMENT MODE POWER MOSFET**TF150P03L****•Thermal resistance**

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case ^②	R _{thJC}	-	-	9	° C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	50	° C/W
Soldering temperature, wavesoldering for 8s	T _{sold}	-	-	265	° C

•Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250uA	-30			V
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} =V _{DS} , I _D =-250uA	-1.1	-1.8	-1.9	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =-28V, V _{GS} =0V			-1.0	uA
Gate- Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
Static Drain-source On Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-8A		13.0	18.0	mΩ
		V _{GS} =-2.5V, I _D =-6A		18.0	23.0	mΩ
Forward Transconductance	g _{FS}	V _{DS} =-10V, I _D =-8A		10		S
Source-drain voltage	V _{SD}	I _S =-8A		0.85	1.00	V

•Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Input capacitance	C _{iss}	f = 1MHz V _{DD} = -15V V _{GS} = 0V	-	1180	-	pF
Output capacitance	C _{oss}		-	162	-	
Reverse transfer capacitance	C _{rss}		-	139	-	

•Gate Charge characteristics(T_a = 25°C)

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Total gate charge	Q _g	V _{DD} = -15V I _D = -10A V _{GS} = -10V	-	26.5	-	nC
Gate - Source charge	Q _{gs}		-	4.51	-	
Gate - Drain charge	Q _{gd}		-	4.45	-	

Note:

- ① Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2% ;
- ② Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate;

Fig.1 Gate-Charge Characteristics

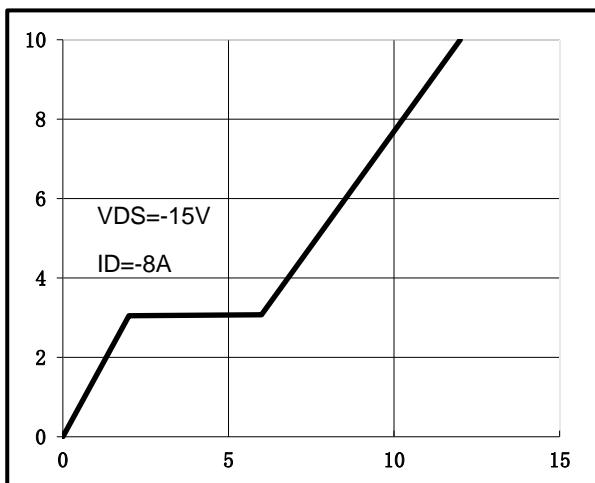


Fig.2 Capacitance Characteristics

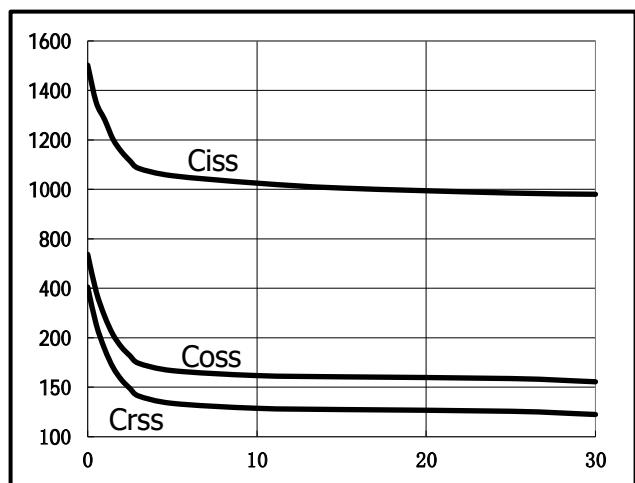


Fig.3 Power Dissipation Derating Curve

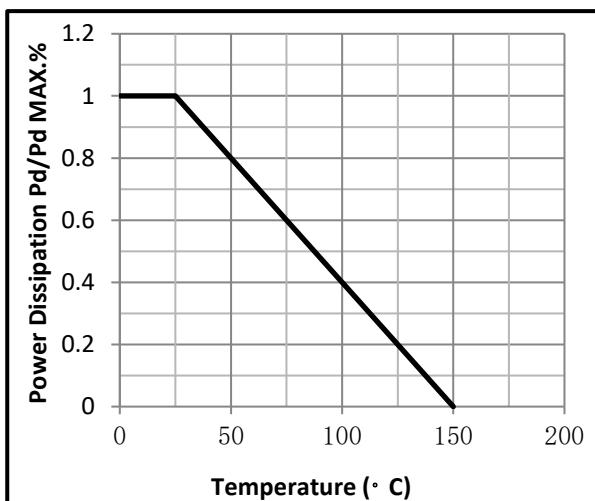


Fig.4 Typical output Characteristics

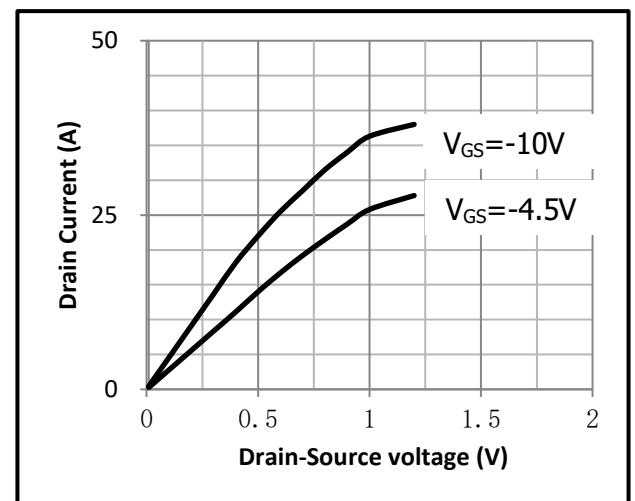


Fig.5 Threshold Voltage V.S Junction Temperature

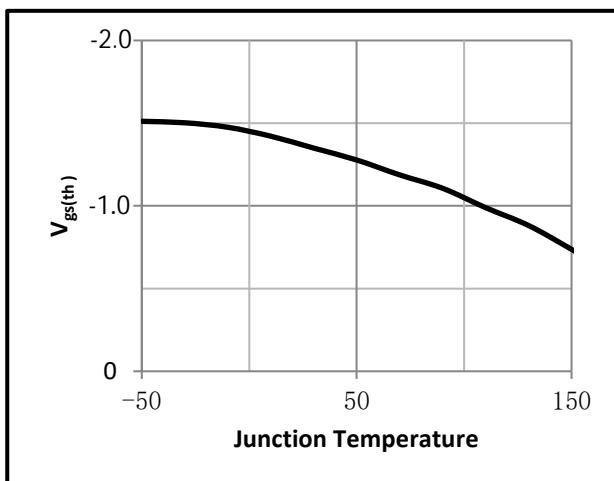


Fig.6 Resistance V.S Drain Current

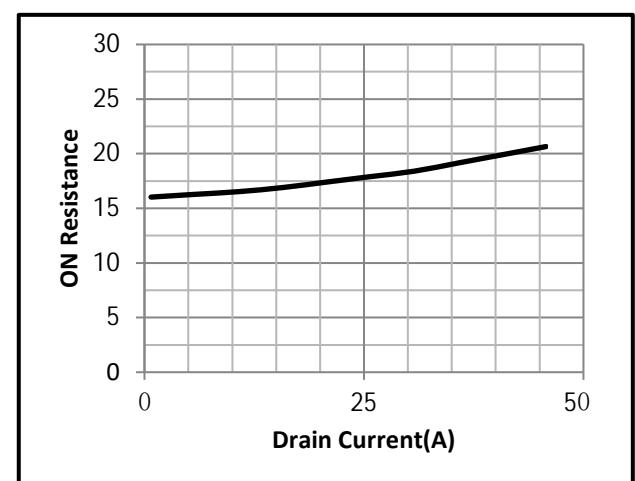


Fig.7 On-Resistance VS Gate Source Voltage

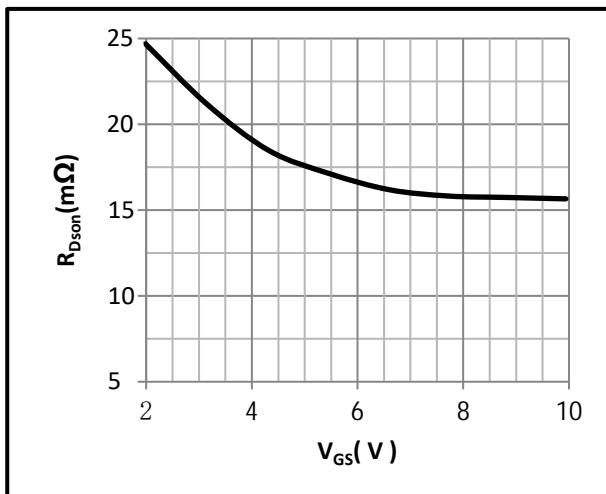


Fig.8 On-Resistance V.S Junction Temperature

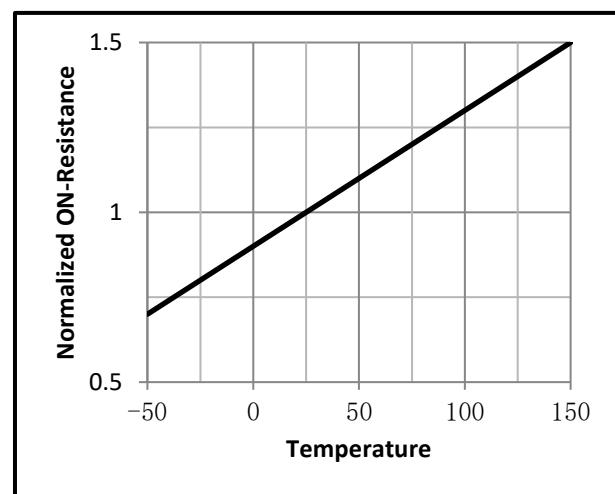


Fig.9 Switching Time Measurement Circuit

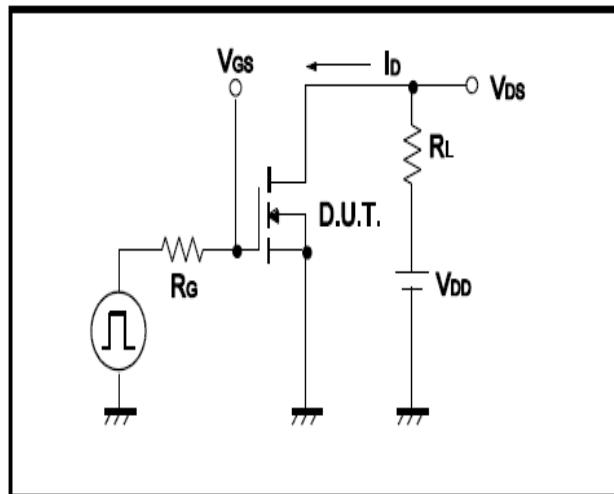


Fig.10 Gate Charge Waveform

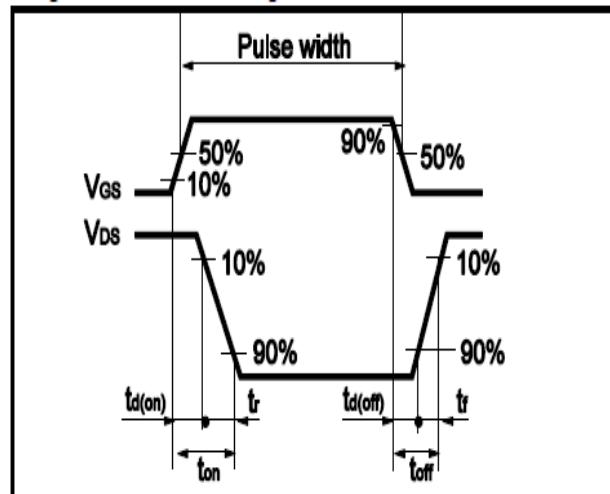


Fig.11 Avalanche Measurement Circuit

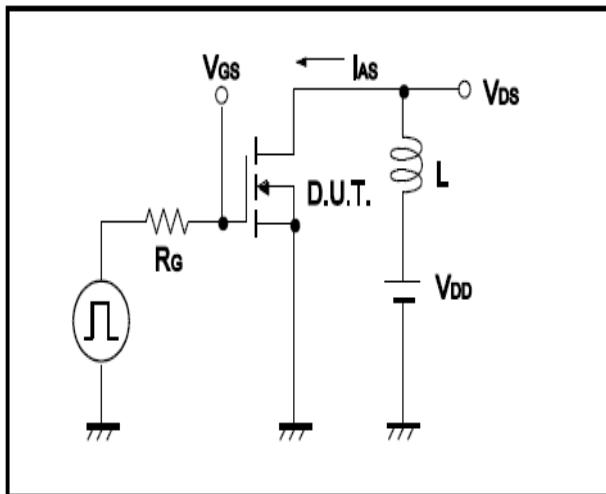
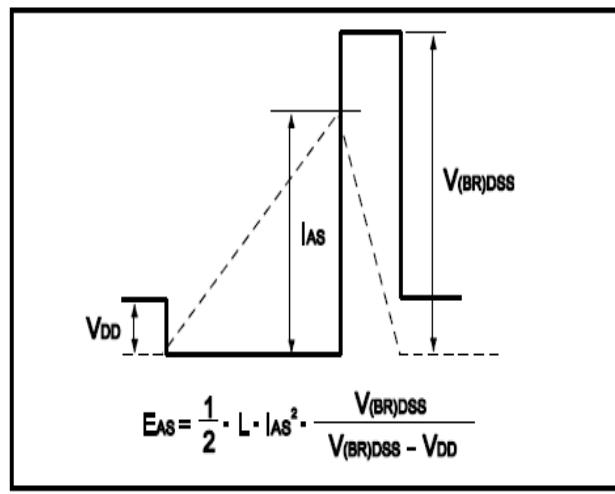


Fig.12 Avalanche Waveform



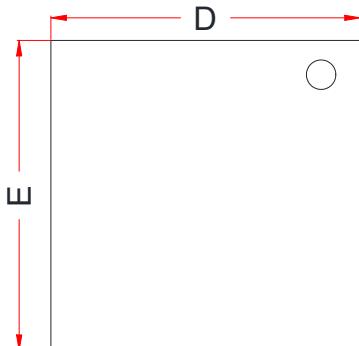


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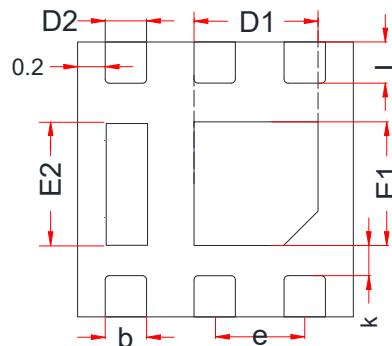
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TF150P03L

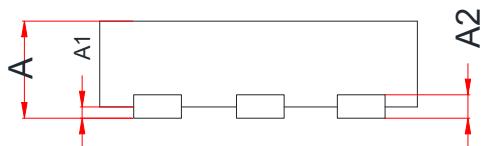
DFN2X2-6L Package Information



TOP VIEW



BOTTOM VIEW



SIDE VIEW

Symbol	Dimensions in Millimeters		
	Min.	Typ.	Max.
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A2	0.203Ref.		
b	0.25	0.30	0.35
D	1.92	2.00	2.07
D1	0.85	0.95	1.05
D2	0.20	0.30	0.40
E	1.92	2.00	2.07
E1	0.70	0.80	0.90
E2	0.70	0.80	0.90
e	0.65 TYP		
L	0.30	0.35	0.40
K	0.20	-	-